

Supporting Information

High-performance Optoelectronic Memory Based on Bilayer MoS₂ grown by Au catalyst

Fengyou Yang ^{†ab}, Shengyao Chen^{†ac}, Huimin Feng^{†ab}, Cong Wang ^d, Xiaofeng Wang^{ab}, Shu Wang^{ab}, Zhican Zhou^{ac}, Bo Li^{ab}, Lijun Ma^a, Haiguang Yang^{ab}, Yong Xie^e, Qian Liu^{*abc}

a. CAS Key Laboratory of Nanosystem and Hierarchical Fabrication, CAS Center for Excellence in Nanoscience, National Center for Nanoscience and Technology, Beijing 100190, P. R. China.

b. University of Chinese Academy of Sciences, Beijing 100049, P. R. China Address here.

c. MOE Key Laboratory of Weak-Light Nonlinear Photonics TEDA Applied Physics Institute, School of Physics, Nankai University, Tianjin 300457, China

d. Division of Physics and Applied Physics, School of Physical and Mathematical Sciences, Nanyang Technological University, Singapore 637371, Singapore.

e. Department of Physics, Beihang University, Beijing 100083, China

[†] These authors contributed equally

E-mail: liuq@nanoctr.cn (Qian Liu)

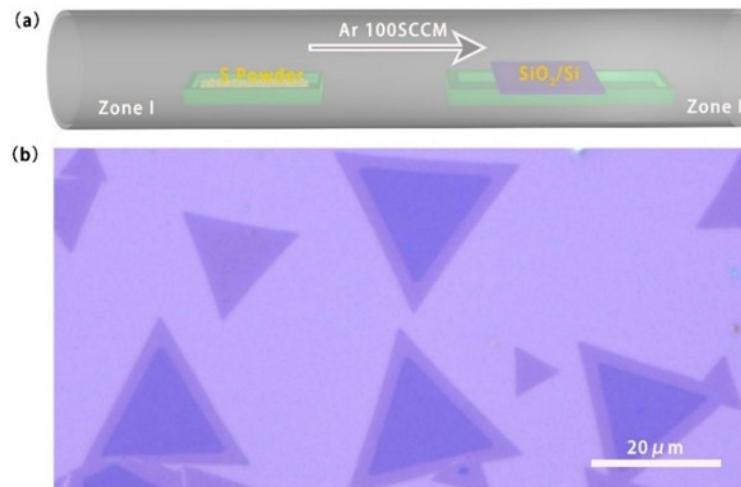


Fig. S1 Monolayer and bilayer MoS₂ directly synthesis on SiO₂/Si substrate without functionated pretreatment. (a) Schematic of the CVD setup for synthesis the monolayer and bilayer MoS₂. **(b)** Optical microscope image of MoS₂ grown on SiO₂/Si substrate by CVD.

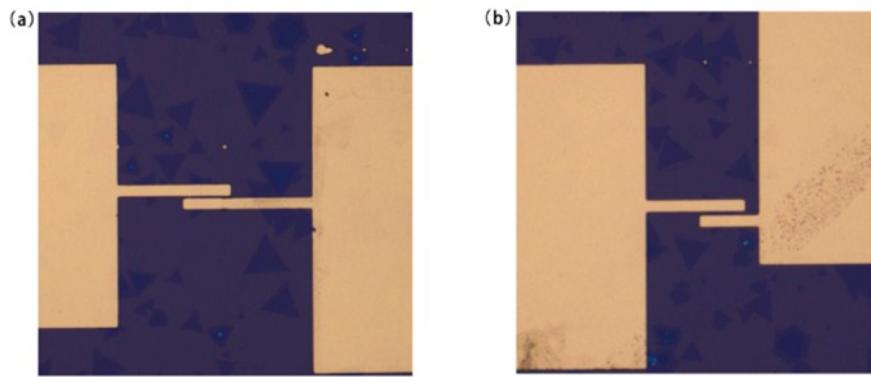


Fig. S2 Optical images of optoelectronic memory based on the monolayer and bilayer MoS2

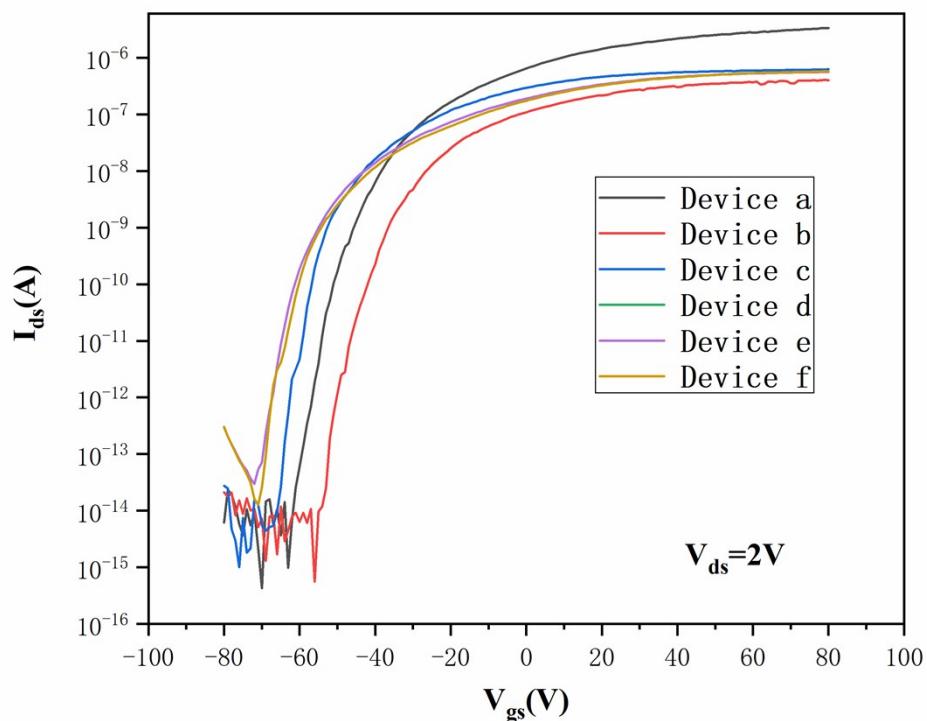


Fig. S3 Transfer characteristics of the Different devices at V_{ds} = 2 V.

Table S1 Ra and Rq of the monolayer and bilayer MoS2.

Roughness	Ra (nm)	Rq (nm)
Monolayer MoS2	0.131	0.173
Bilayer MoS2	0.0849	0.107

Table S2 Comparison between existing MoS₂ memory and our bilayer MoS₂ memory..

MoS₂ memory structure	on/off ratio	Retention time	Cyclic	Reference
Planar Au/Ti/MoS ₂ /Ti/Au	8×10^4	2.2×10^4 s	>10	Our work
Planar Au/Cr/MoS ₂ /Cr/Au/ substrate Si/Au/Al ₂ O ₃ /AuNPs/cPVP	$\sim 10^5$	10^3 s	>200	<i>ACS Appl. Mater. Interfaces</i> 2017, 9, 31, 26357-26362
Planar Au/MoS ₂ /Au	4700	10^4 s	—	<i>Nature communications</i> , 2017, 8, 14734